## DISCRETE SEMICONDUCTORS

## DATA SHEET



# **PESD5V2S18U**ESD protection array

Product data sheet 2003 Apr 28



## **ESD** protection array

## PESD5V2S18U

#### **FEATURES**

- Uni-directional ESD protection of up to 18 lines
- Maximum peak reverse power:  $P_{PP} = 100 \text{ W}$  at  $t_p = 8/20 \text{ }\mu\text{s}$
- Low clamping voltage:
  V<sub>CL</sub> = 12 V max. at I<sub>ZSM</sub> = 10 A
- Low leakage current:
  I<sub>R</sub> = 100 nA typ. at V<sub>RWM</sub> = 5.2 V
- IEC 61000-4-2, level 4 (ESD);
  15 kV (air) and 8 kV (contact).

#### **APPLICATIONS**

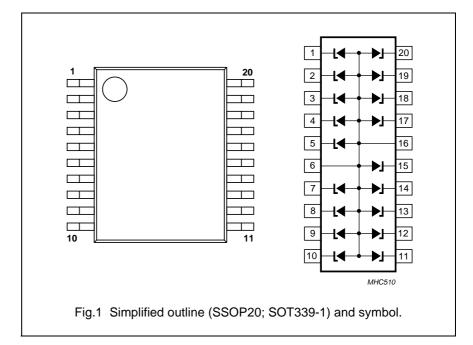
- · Printer parallel ports
- · Computers and peripherals
- · Communication systems.

## **DESCRIPTION**

Monolithic ESD protection device designed to protect up to 18 transmission or data lines from the damage caused by electrostatic discharge (ESD) and surge pulses.

#### **PINNING**

PIN	DESCRIPTION
1 to 5	cathode (k1 to k5)
6 and 16	common anode (a1; a2)
7 to 15	cathode (k6 to k14)
17 to 20	cathode (k15 to k18)



#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I <sub>PP</sub>	non-repetitive peak reverse current	t <sub>p</sub> = 8/20 μs	_	10	Α
P <sub>PP</sub>	non-repetitive peak reverse power dissipation	t <sub>p</sub> = 8/20 μs	_	100	W
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C
	electrostatic discharge voltage	IEC 61000-4-2 (contact discharge)	30	_	kV
		HBM MIL-Std 883	10	_	kV

## **ESD** standards compliance

IEC 61000-4-2, level 4 (ESD)	>15 kV (air); >8 kV (contact)
HBM MIL-Std 883, class 3	>4 kV

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## THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	PARAMETER CONDITIONS		UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	one or more diodes loaded	135	K/W

## Note

1. Refer to SOT339-1 standard mounting conditions.

## **ELECTRICAL CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>RWM</sub>	crest working reverse voltage		_	_	5.2	V
I <sub>R</sub>	reverse current	V <sub>RWM</sub> = 5.2 V	-	0.1	1	μΑ
V <sub>CL</sub>	clamping voltage	$I_{ZSM} = 3 \text{ A}; t_p = 8/20 \mu\text{s}; \text{ see Fig.5}$	-	-	8	V
		$I_{ZSM} = 10 \text{ A}; t_p = 8/20 \mu \text{s}; \text{ see Fig.5}$	-	-	12	V
$V_{BR}$	breakdown voltage	$I_Z = 5 \text{ mA}$	6.4	6.8	7.2	V
r <sub>diff</sub>	differential resistance	$I_Z = 1 \text{ mA}$	_	_	40	Ω
		$I_Z = 5 \text{ mA}$	_	_	8	Ω
$C_d$	diode capacitance	$V_R = 0$ ; f = 1 MHz; see Fig.4	_	100	_	pF

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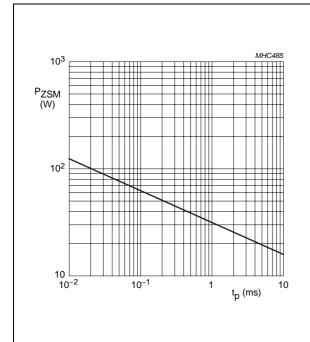
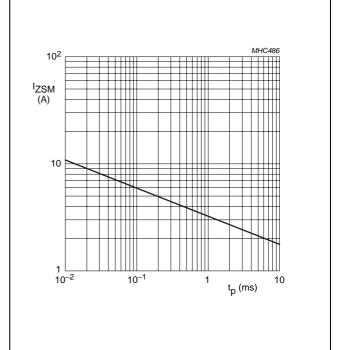
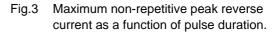


Fig.2 Maximum non-repetitive peak reverse power as a function of pulse duration.





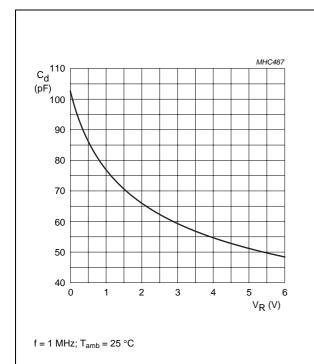
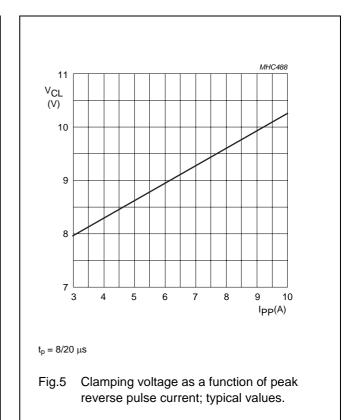


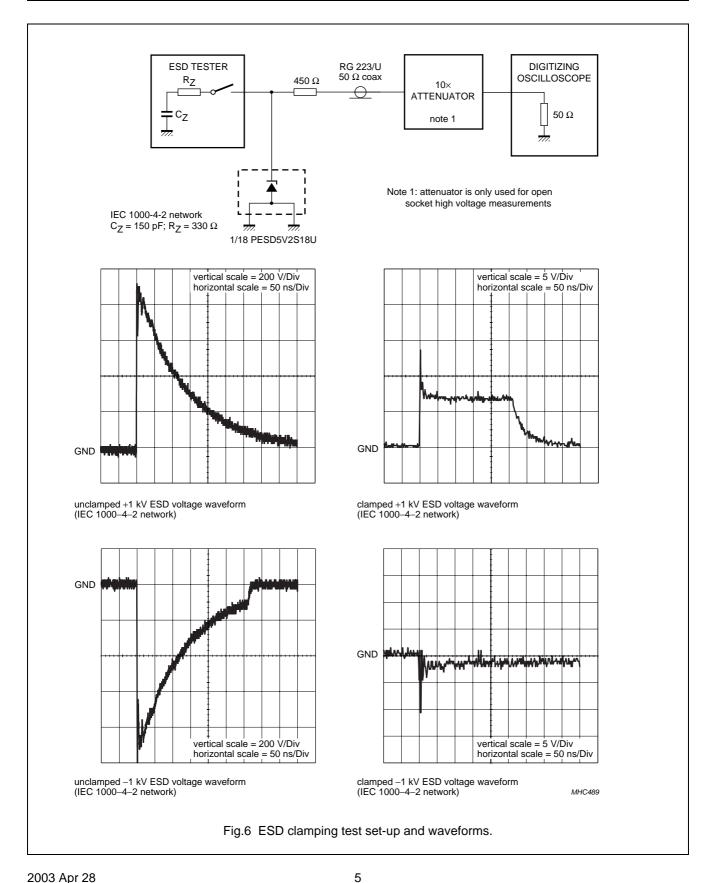
Fig.4 Diode capacitance as a function of reverse voltage; typical values.



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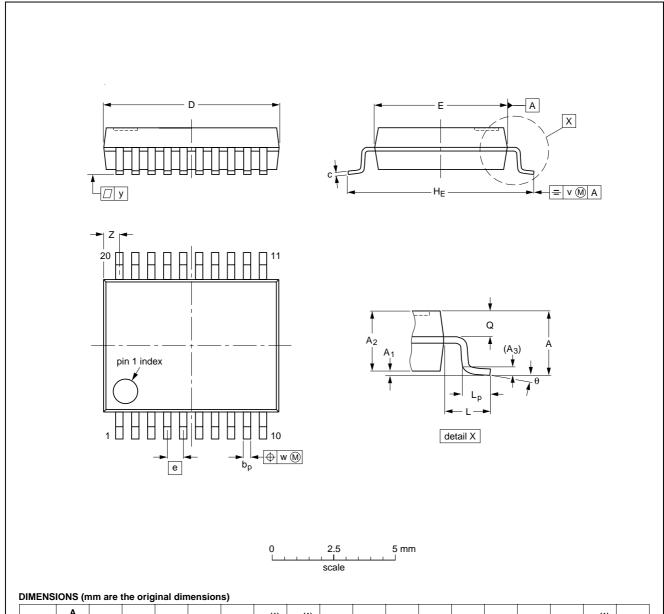
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## **PACKAGE OUTLINE**

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

#### Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT339-1		MO-150				<del>99-12-27</del> 03-02-19

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#### **DATA SHEET STATUS**

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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